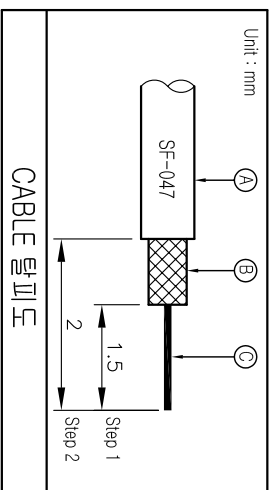
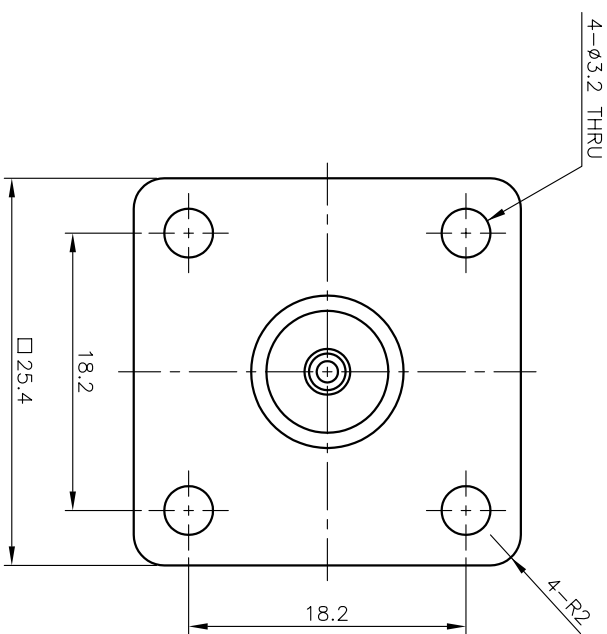
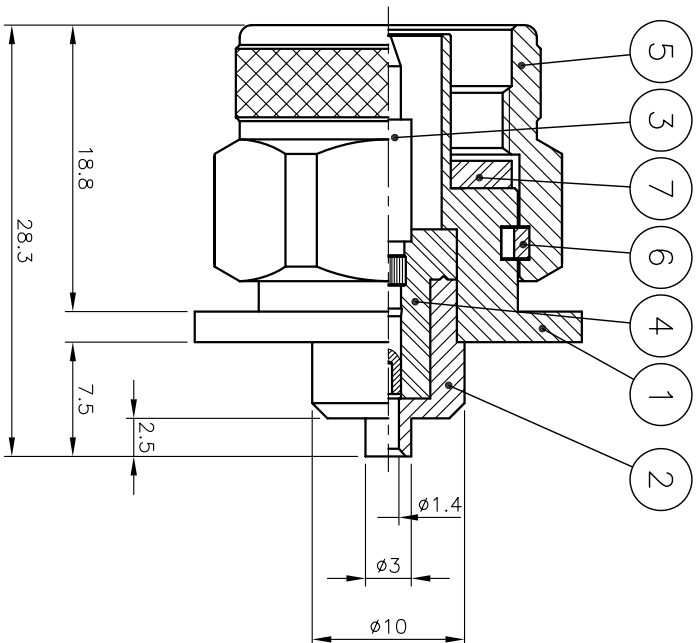


REVISION			DATE
REV	DESCRIPTION		
1R	Initial Registration	2010.03.25.	



CABLE 탈피도

NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
7	GASKET	1	SILICONE RUB		DGK00013-N/1
6	SPRING RING	1	MBSBD	Nickel Plate	DSR00020-5/1
5	COUPLING CAP	1	SUS	Passivated	DCU000068-5/1
4	INSULATOR	1	TEFLON		DIN00762-N/1
3	CONTACT	1	BeCu	Silver Plate	DCT01337-5/1
2	BODY (B)	1	MBSBD	SUCO Plate	DBD01318-5/1
1	BODY (A)	1	MBSBD	SUCO Plate	DBD00983-5/1

TOLERANCE	Decimal	±0.1
Angle	±1°	
MATERIAL	CHECKED BY	
FINISH	DRAWN BY	

DATE	2010. 03. 25.	TITLE	N-SP-H4-047
APPROVED BY	Y.H. CHOI	DWG NO.	CN00767-7/3
SCALE	2.5/1	UNIT	mm
FINISH		REVISION	1 of 1

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